DATA SHEET



GaAs INTEGRATED CIRCUIT

μ PG2157T5F

NON-REFLECTIVE HIGH POWER SPDT SWITCH FOR WIMAX

DESCRIPTION

The UPG2157T5F is a non-reflective (50 Ω termination) GaAs MMIC high power SPDT (Single Pole Double Throw) switch for WiMAX. This device can operate from frequency 2.3 to 5.85 GHz, with low insertion loss and high isolation.

This device is housed in a 12-pin plastic QFN (\underline{Q} uad \underline{F} lat \underline{N} on-leaded) package, and is suitable for high-density surface mounting.

FEATURES

Control voltage : V_{cont} (H) = 2.5 to 3.3 V (3.0 V TYP.)

: $V_{cont(L)} = 0 \text{ to } 0.4 \text{ V } (0 \text{ V TYP.})$

• Low insertion loss : Lins1 = 0.60 dB TYP. @ f = 2.3 to 2.7 GHz, $V_{cont(H)} = 3.0$ V, $V_{cont(L)} = 0$ V

: Lins2 = 0.60 dB TYP. @ f = 3.3 to 3.8 GHz, $V_{cont\,(H)}$ = 3.0 V, $V_{cont\,(L)}$ = 0 V

: Lins3 = 0.80 dB TYP. @ f = 5.15 to 5.85 GHz, $V_{cont(H)} = 3.0 \text{ V}$, $V_{cont(L)} = 0 \text{ V}$

• High isolation : ISL1 = 28 dB TYP. @ f = 2.3 to 2.7 GHz, $V_{cont (H)} = 3.0$ V, $V_{cont (L)} = 0$ V

: ISL2 = 25 dB TYP. @ f = 3.3 to 3.8 GHz, $V_{cont (H)} = 3.0$ V, $V_{cont (L)} = 0$ V : ISL3 = 22 dB TYP. @ f = 5.15 to 5.85 GHz, $V_{cont (H)} = 3.0$ V, $V_{cont (L)} = 0$ V

: $P_{in (1 dB)} \ge +37.0 dBm TYP$. @ f = 2.5 GHz, $V_{cont (H)} = 3.0 V$, $V_{cont (L)} = 0 V$

: Pin (1 dB) \geq +37.0 dBm TYP. @ f = 5.85 GHz, Vcont (H) = 3.0 V, Vcont (L) = 0 V

High-density surface mounting: 12-pin plastic QFN package (3.0 x 3.0 x 0.75 mm)

APPLICATIONS

Power Handling

· Antenna switch for WiMAX, 802.11a/b/g access point

ORDERING INFORMATION

Part Number	Order Number	Package	Marking	Supplying Form
μPG2157T5F-E2	μPG2157T5F-E2-A	12-pin plastic QFN (Pb-Free)	2157	Embossed tape 8 mm wide Pin 1 indicates roll-in direction of tape Qty 3 kpcs/reel

Remark To order evaluation samples, contact your nearby sales office.

Part number for sample order: µPG2157T5F-A

Caution Observe precautions when handling because these devices are sensitive to electrostatic discharge.

The information in this document is subject to change without notice. Before using this document, please confirm that this is the latest version.

Pin Name

GND

GND

GND

V_{cont}2

GND

OUTPUT2

GND

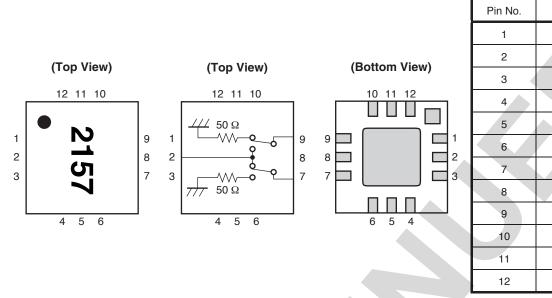
OUTPUT1

GND

 $V_{\text{cont}}\mathbf{1}$

GND

PIN CONNECTIONS AND INTERNAL BLOCK DIAGRAM



Remark Exposed pad: GND

TRUTH TABLE

V _{cont} 1	V _{cont} 2	INPUT-OUTPUT1	INPUT-OUTPUT2
High	Low	ON	OFF
Low	High	OFF	ON

ABSOLUTE MAXIMUM RATINGS (TA = +25°C, unless otherwise specified)

Parameter	Symbol	Ratings	Unit
Switch Control Voltage	Vcont	+6.0	V
Input Power (ON Port, peak)	Pin	+38	dBm
Input Power (ON Port, average)	Pin	+28	dBm
Input Power (OFF Port)	Pin (OFF)	+20	dBm
Operating Ambient Temperature	Та	-45 to +85	°C
Storage Temperature	Tstg	-55 to +150	°C

RECOMMENDED OPERATING RANGE (TA = +25°C, unless otherwise specified)

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
Operating Frequency	f _{opt} 1	2.3	-	2.7	GHz
	f _{opt} 2	3.3	-	3.8	GHz
	f _{opt} 3	5.15	-	5.85	GHz
Switch Control Voltage (H)	V _{cont (H)}	2.5	3.0	3.3	V
Switch Control Voltage (L)	V _{cont (L)}	0	0	0.4	V

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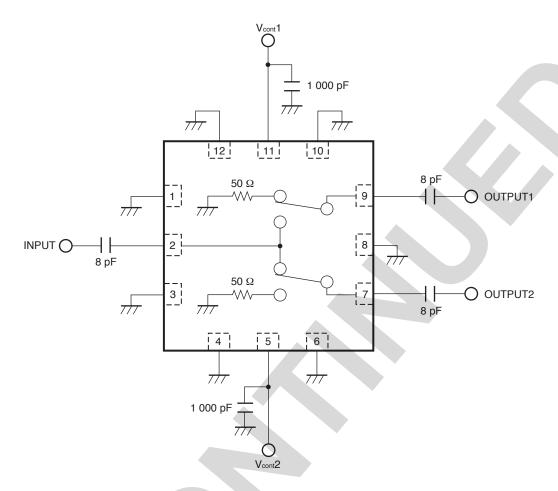
ELECTRICAL CHARACTERISTICS

(TA = +25°C, V_{cont} (H) = 3.0 V, V_{cont} (L) = 0 V, DC blocking capacitors = 8 pF, unless otherwise specified)

Parameter	Symbol	Test Conditions	MIN.	TYP.	MAX.	Unit
Insertion Loss 1	Lins1	f = 2.3 to 2.7 GHz	-	0.60	0.85	dB
Insertion Loss 2	Lins2	f = 3.3 to 3.8 GHz	-	0.60	0.85	dB
Insertion Loss 3	Lins3	f = 5.15 to 5.85 GHz	ı	0.80	1.05	dB
Isolation 1 (INPUT-OFF Port)	ISL1	f = 2.3 to 2.7 GHz	25	28		dB
Isolation 2 (INPUT-OFF Port)	ISL2	f = 3.3 to 3.8 GHz	22	25	-	dB
Isolation 3 (INPUT-OFF Port)	ISL3	f = 5.15 to 5.85 GHz	19	22	-	dB
Isolation 4 (OUTPUT1-OUTPUT2)	ISL4	f = 2.3 to 2.7 GHz	23	26	-	dB
Isolation 5 (OUTPUT1-OUTPUT2)	ISL5	f = 3.3 to 3.8 GHz	20	23	ı	dB
Isolation 6 (OUTPUT1-OUTPUT2)	ISL6	f = 5.15 to 5.85 GHz	18	21	ı	dB
Input Return Loss 1	RLin1	f = 2.3 to 2.7 GHz	1	20	-	dB
Input Return Loss 2	RLin2	f = 3.3 to 3.8 GHz	1	20	ı	dB
Input Return Loss 3	RLin3	f = 5.15 to 5.85 GHz	-	20	-	dB
Output Return Loss 1	RLout1	f = 2.3 to 2.7 GHz	-	20	ı	dB
Output Return Loss 2	RLout2	f = 3.3 to 3.8 GHz	ı	20	ı	dB
Output Return Loss 3	RLout3	f = 5.15 to 5.85 GHz	ı	20	ı	dB
Return Loss (OFF Port)	RL	f = 2.3 to 2.7 GHz	ı	15	ı	dB
		f = 3.3 to 3.8 GHz	ı	15	ı	dB
		f = 5.15 to 5.85 GHz	ı	15	ı	dB
1 dB Loss Compression	Pin (1 dB)	f = 2.5 GHz	ı	≥ +37.0	ı	dBm
Input Power Note		f = 5.85 GHz	ı	≥ +37.0	-	dBm
Switch Control Current	Icont		ı	20	30	μΑ
Switch Control Speed	tsw	50% CTL to 90/10% RF	-	100	-	ns

Note Pin (1 dB) is the measured input power level when the insertion loss increases 1dB more than that of the linear range.

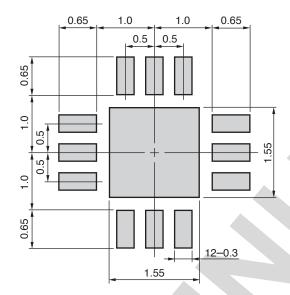
EVALUATION CIRCUIT



The application circuits and their parameters are for reference only and are not intended for use in actual design-ins.

MOUNTING PAD LAYOUT DIMENSIONS

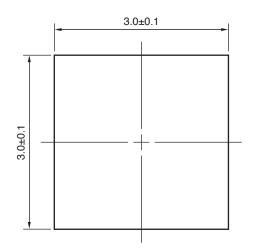
12-PIN PLASTIC QFN (UNIT: mm)

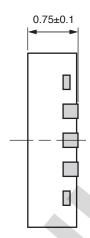


Remark The mounting pad layouts in this document are for reference only.

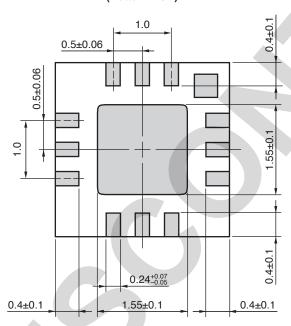
PACKAGE DIMENSIONS

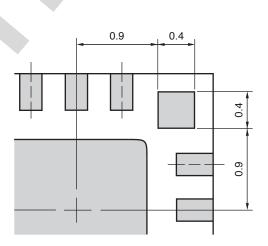
12-PIN PLASTIC QFN (UNIT: mm)





(Bottom View)





Dimensions of pin No.1 indication

RECOMMENDED SOLDERING CONDITIONS

This product should be soldered and mounted under the following recommended conditions. For soldering methods and conditions other than those recommended below, contact your nearby sales office.

Soldering Method	Soldering Conditions		Condition Symbol
Infrared Reflow	Peak temperature (package surface temperature) Time at peak temperature Time at temperature of 220°C or higher Preheating time at 120 to 180°C Maximum number of reflow processes Maximum chlorine content of rosin flux (% mass)	: 260°C or below : 10 seconds or less : 60 seconds or less : 120±30 seconds : 3 times : 0.2%(Wt.) or below	IR260
Wave Soldering	Peak temperature (molten solder temperature) Time at peak temperature Preheating temperature (package surface temperature) Maximum number of flow processes Maximum chlorine content of rosin flux (% mass)	: 260°C or below : 10 seconds or less : 120°C or below : 1 time : 0.2%(Wt.) or below	WS260
Partial Heating	Peak temperature (terminal temperature) Soldering time (per side of device) Maximum chlorine content of rosin flux (% mass)	: 350°C or below : 3 seconds or less : 0.2%(Wt.) or below	HS350

Caution Do not use different soldering methods together (except for partial heating).



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M8E 02.11-1

Caution

GaAs Products

This product uses gallium arsenide (GaAs).

GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points.

- Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below.
 - Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials.
- 2. Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal.
- Do not burn, destroy, cut, crush, or chemically dissolve the product.
- Do not lick the product or in any way allow it to enter the mouth.





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Mercury	<1000 PPM	Not De	etected	
Cadmium	< 100 PPM	Not Detected		
Hexavalent Chromium	< 1000 PPM	Not De	etected	
PBB	< 1000 PPM	Not De	etected	
PBDE	< 1000 PPM	Not Detected		

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